

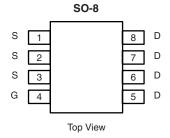
RoHS

COMPLIANT

Vishay Siliconix

# N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)			
30	0.0079 at V <sub>GS</sub> = 10 V	19.3 <sup>a</sup>	8.8 nC			
	0.010 at V <sub>GS</sub> = 4.5 V	17.1 <sup>a</sup>	0.0110			



#### FEATURES

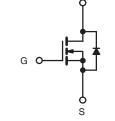
- Halogen-free
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested

### **APPLICATIONS**

- DC/DC
  - High Side
  - VRM



- Server



Ordering Information: Si4162DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20		
	T <sub>C</sub> = 25 °C		19.3 <sup>a</sup>		
Continuous Drain Current $(T = 150 ^{\circ}\text{C})$	T <sub>C</sub> = 70 °C		15.4		
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	13.6 <sup>b, c</sup>	•	
	T <sub>A</sub> = 70 °C		10.9 <sup>b, c</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	70		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	31		
Avalanche Energy		E <sub>AS</sub>	48	mJ	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		4.2 <sup>a</sup>	٨	
Commuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.1 <sup>b, c</sup>	A	
	T <sub>C</sub> = 25 °C		5		
Maximum Power Dissinction	T <sub>C</sub> = 70 °C	ъ	3.2	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>b, c</sup>	vv	
	T <sub>A</sub> = 70 °C		1.6 <sup>b, c</sup>		
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C		
Soldering Recommendations (Peak Tempera		260	°C		

#### THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	38	50	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	20	25	0/00	

#### Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 85 °C/W.

# Si4162DY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		32		m\//º/	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i <sub>D</sub> = 250 μA		- 5.5		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1		3	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current		$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			5	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	50			Α	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A	0.0065 0.007		0.0079	1	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 14 \text{ A}$		0.0082	0.010	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A		70		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			1155		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		260			
Reverse Transfer Capacitance	C <sub>rss</sub>			95			
Total Gate Charge	0	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		20	30	nC	
	Qg			8.8	14		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$		3.5			
Gate-Drain Charge	Q <sub>gd</sub>			2.2			
Gate Resistance	R <sub>g</sub>	f = 1 MHz		1.0	2.0	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			20	30	-	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 15 $\Omega$		15	25		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 1.0 A, $V_{GEN}$ = 4.5 V, $R_g$ = 17 $\Omega$		25	40		
Fall Time	t <sub>f</sub>			10	15		
Turn-On Delay Time	t <sub>d(on)</sub>			14	20	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 15 $\Omega$		9	15		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 1.0 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		25	40		
Fall Time	t <sub>f</sub>			9	15		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			30	٨	
Pulse Diode Forward Current	I <sub>SM</sub>				70	A	
Body Diode Voltage	V <sub>SD</sub>	$I_{S} = 4.0 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			21	42	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	L = 4.0.0 dl/dt = 100.0/m T = 05.00		15	30	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 4.0 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		12.6			
Reverse Recovery Rise Time t <sub>b</sub>				8.4		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

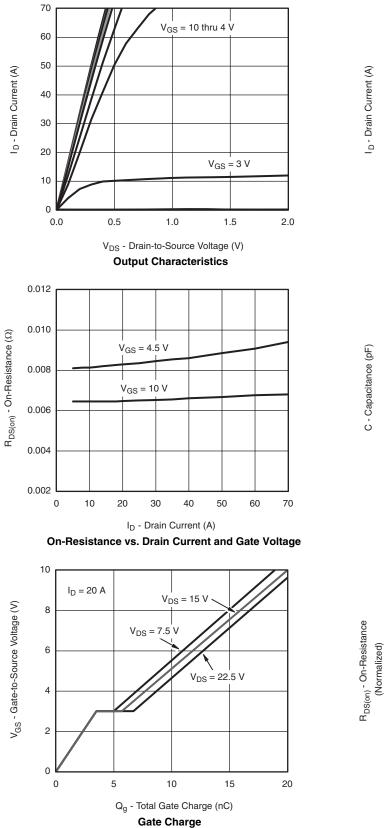
b. Guaranteed by design, not subject to production testing.

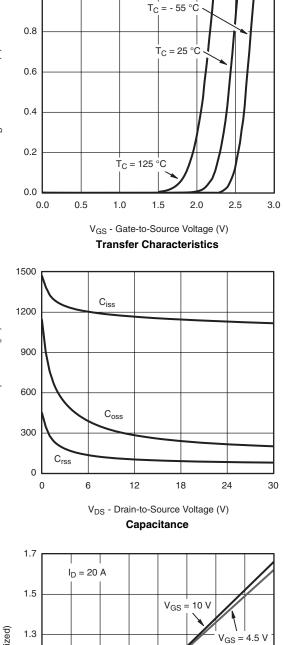
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



# Si4162DY Vishay Siliconix

## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





1.0

125

150

1.1

0.9

0.7

- 50

- 25

0

25

50

T<sub>J</sub> - Junction Temperature (°C)

**On-Resistance vs. Junction Temperature** 

75

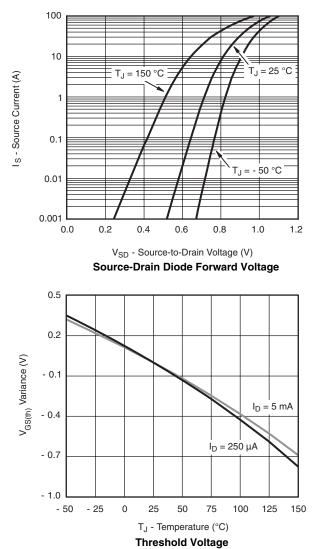
100

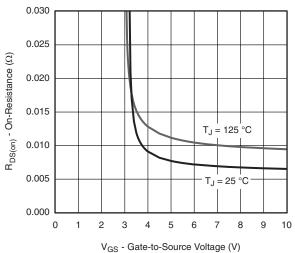
# Si4162DY

## Vishay Siliconix

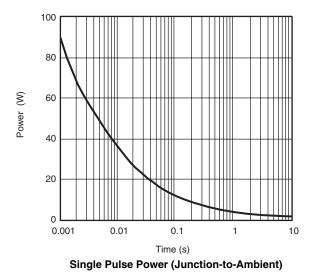


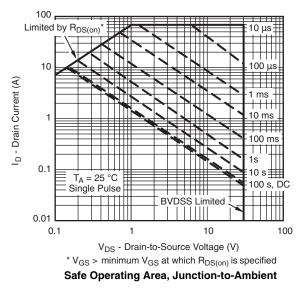
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





On-Resistance vs. Gate-to-Source Voltage



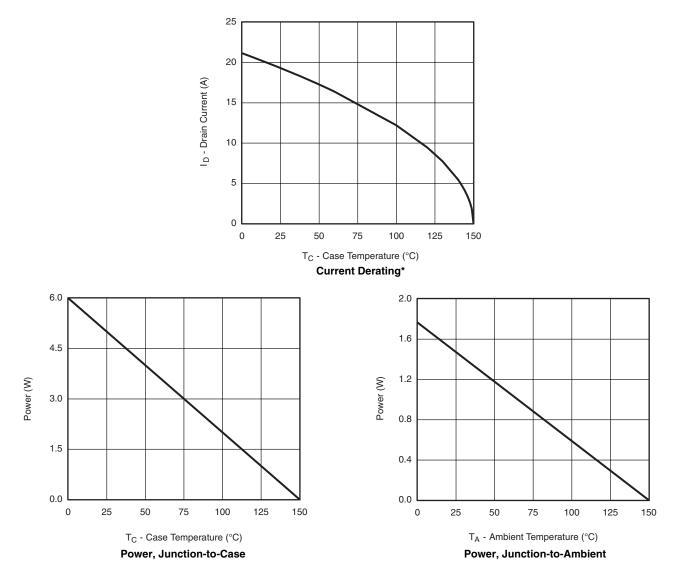


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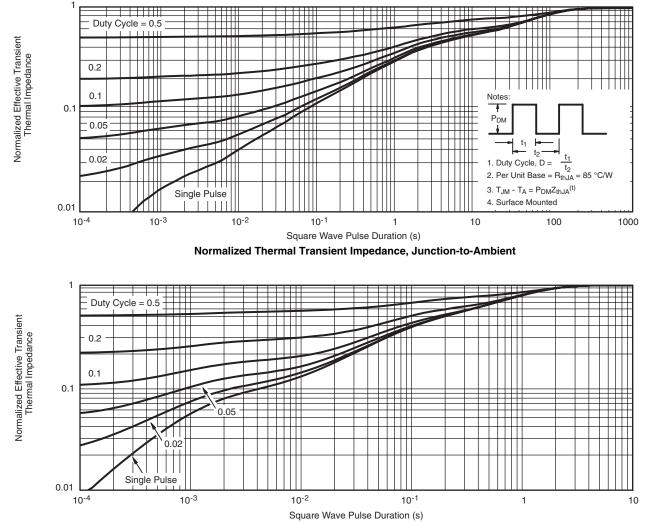
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

## **Vishay Siliconix**

## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?68967.



# Package Information

Vishay Siliconix

## SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





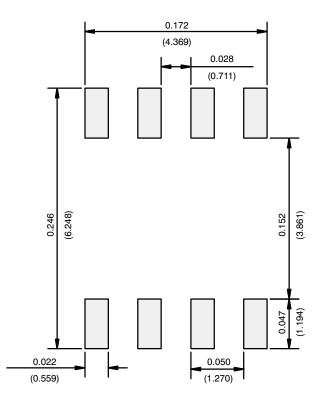
	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

# **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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